

GENERAL DESCRIPTION

The XRK69774 is a PLL based LVCMOS Clock Generator targeted for high performance and low skew clock distribution applications. The XRK69774 can select between one of two reference inputs and provides 15 LVCMOS outputs - 14 outputs (2 banks of 5 and 1 bank of 4) for clock distribution and 1 for feedback.

The XRK69774 has two LVCMOS inputs to support clock redundancy. Switching the internal reference clock is controlled by the control input, CLK_SEL.

The XRK69774 uses PLL technology to frequency lock its outputs to the input reference clock. The divider in the feedback path will determine the frequency of the VCO. Each of the separate output banks can individually divide down the VCO output frequency. This allows the XRK69774 to generate a multitude of different bank frequency ratios and output-to-input frequency ratios.

The outputs of the XRK69774 can be immobilized, in the low state, by use of the stop clock feature. Global output disabling and reset can be achieved with the control input MR/OE.

The XRK69774 has an output frequency range of 8.33MHz

to 125MHz and an input frequency range of 4.16MHz to 62.5MHz.

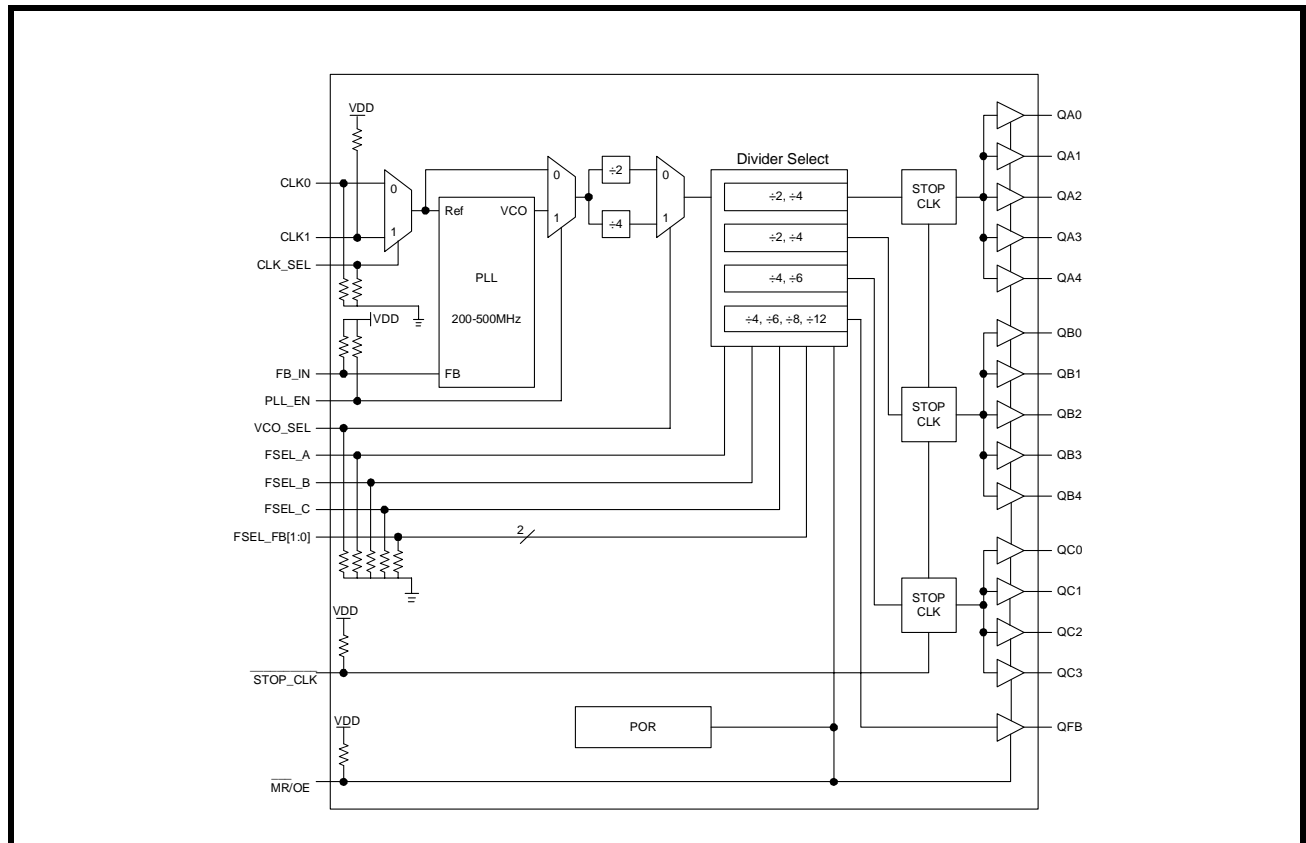
FEATURES

- Fully Integrated PLL
- 15 LVCMOS outputs
 - 2 banks with 5 outputs and 1 with 4 outputs each
 - 1 dedicated feedback for frequency control
 - Output Frequency of each Bank can be individually controlled
- VCO Range 200MHz to 500MHz
- Output freq. range: 8.33MHz to 125MHz
- Max Output Skew of 175ps
- Max Cycle-to-cycle jitter: 90ps
- LVCMOS inputs for reference clock source

APPLICATIONS

- System Clock generator
- Zero Delay Buffer

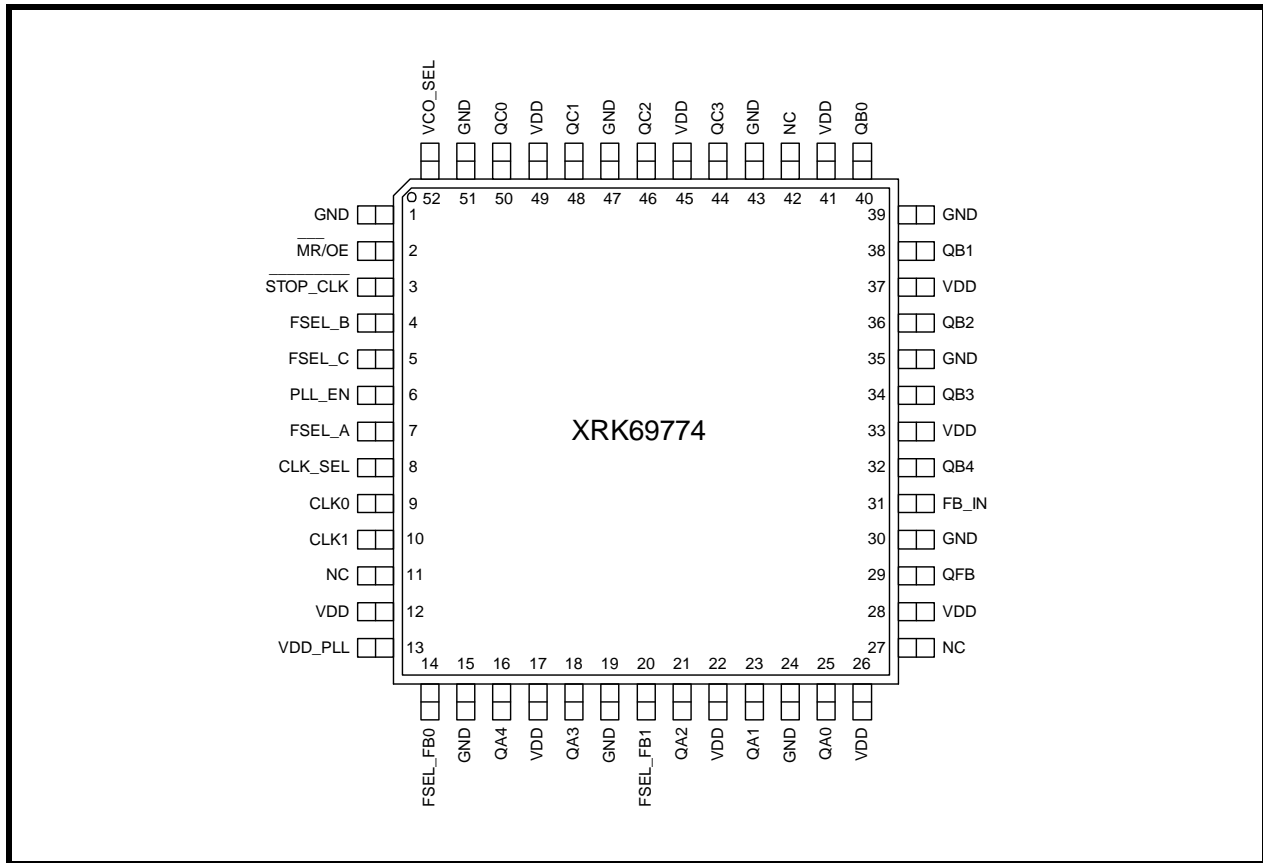
FIGURE 1. BLOCK DIAGRAM OF THE XRK69774



PRODUCT ORDERING INFORMATION

PRODUCT NUMBER	PACKAGE TYPE	OPERATING TEMPERATURE RANGE
XRK69774CR	52-LEAD LQFP	0°C to +70°C
XRK69774IR	52-LEAD LQFP	-40°C to +85°C

FIGURE 2. PIN OUT OF THE XRK69774



PIN DESCRIPTIONS

PIN #	NAME	TYPE	DESCRIPTION
1, 15, 19, 24, 30, 35, 39, 43, 47, 51	GND	POWER	Power supply ground
2	MR/OE	INPUT	Master reset and output enable. High = output enabled, Low = device reset & outputs tri-stated NOTE: 25kΩ Pull-Up resistor.
3	STOP_CLK	INPUT	Clock input for serial control NOTE: 25kΩ Pull-Up resistor.
7 4 5	FSEL_A, FSEL_B, FSEL_C	INPUT	Select inputs for control of feedback divide value. NOTE: Each input has a 25kΩ Pull-Down resistor.
6	PLL_EN	INPUT	PLL bypass High = PLL Enabled. Low = PLL bypass NOTE: 25kΩ Pull-Up resistor.
8	CLK_SEL	INPUT	CLK0 or CLK1 Select. High = CLK1 selected, Low = CLK0 selected NOTE: 25kΩ Pull-Down resistor.
9 10	CLK0 CLK1	INPUT INPUT	PLL Reference Clock Inputs NOTE: CLK1 has 25kΩ Pull-Up resistor. CLK0 has 25kΩ Pull-Down resistor.
11, 27, 42	NC	-	NO CONNECT
12, 17, 22, 26, 28, 33, 37, 41, 45, 49	VDD	POWER	Power supply
13	VDD_PLL	POWER	Analog supply for PLL
14 20	FSEL_FB0 FSEL_FB1	INPUT INPUT	Frequency Divider Select for QFB output NOTE: Each input has a 25kΩ Pull-Down resistor.
16, 18, 21, 23, 25	QA[4:0]	OUTPUT	Clock outputs (Bank A)
29	QFB	OUTPUT	Feedback clock output
31	FB_IN	INPUT	Feedback input NOTE: 25kΩ Pull-Up resistor.
32, 34, 36, 38, 40	QB[4:0]	OUTPUT	Clock outputs (Bank B)
44, 46, 48, 50	QC[3:0]	OUTPUT	Clock outputs (Bank C)
52	VCO_SEL	INPUT	VCO select. high = VCO/1, low = VCO/2. NOTE: 25kΩ Pull-Down resistor.

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1.0 ELECTRICAL SPECIFICATIONS

TABLE 1: GENERAL SPECIFICATIONS

SYMBOL	CHARACTERISTICS	CONDITION	MIN	TYP	MAX	UNIT
V _{TT}	Output Termination Voltage			V _{DD} ÷2		V
ESD _{MM}	ESD Protection (Machine model)		200			V
ESD _{HBM}	ESD Protection (Human body model)		2000			V
LU	Latch-up Immunity		200			mA
C _{IN}	Input capacitance	Per input		4		pf

TABLE 2: ABSOLUTE MAXIMUM RATINGS

SYMBOL	CHARACTERISTICS	CONDITION	MIN	TYP	MAX	UNIT
V _{DD}	Supply Voltage		-0.3		3.9	V
V _{IN}	DC Input Voltage		-0.3		V _{DD} + 0.3	V
V _{OUT}	DC Output Voltage		-0.3		V _{DD} + 0.3	V
I _{IN}	DC Input Current				+/-20	mA
I _{OUT}	DC Output Current				+/-50	mA
T _S	Storage Temperature		-65		125	°C

TABLE 3: DC CHARACTERISTICS (V_{DD} = 3.3V +/- 5%)

SYMBOL	CHARACTERISTICS	CONDITION	MIN	TYP	MAX	UNIT
V _{DD_PLL}	PLL Supply Voltage	LVCMOS	3.0		V _{DD}	V
V _{IH}	Input High Voltage	LVCMOS	2.0		V _{DD} + 0.3	V
V _{IL}	Input Low Voltage	LVCMOS			0.8	V
V _{OH}	Output High Voltage	I _{OH} = -24mA	2.4			V
V _{OL}	Output Low Voltage	I _{OL} = 24mA I _{OL} = 12mA			0.55 0.30	V
Z _{OUT}	Output Impedance			14 -17		Ω
I _{PU}	Input Pull-Up/Down Current	V _{IN} = GND or V _{DD}			±200	μA
I _{DD_PLL}	PLL Supply Current	@ V _{DD_PLL} Pin		5.0	7.5	mA
I _{DDQ}	Quiescent Supply Current	All V _{DD} pins			8	mA

TABLE 4: AC CHARACTERISTICS ($V_{DD} = 3.3V \pm 5\%$)

SYMBOL	CHARACTERISTICS	CONDITION	MIN	TYP	MAX	UNIT
f_{REF}	Input reference frequency	$\div 8$ feedback	25.0		62.5	MHz
		$\div 12$ feedback	16.6		41.6	MHz
		$\div 16$ feedback	12.5		31.25	MHz
		$\div 24$ feedback	8.33		20.83	MHz
		$\div 32$ feedback	6.25		15.625	MHz
		$\div 48$ feedback	4.16		10.41	MHz
		PLL bypass mode				250
f_{VCO}	VCO frequency range		200		500	MHz
f_{MAX}	Output frequency	$\div 4$ output	50.0		125	MHz
		$\div 8$ output	25.0		62.5	MHz
		$\div 12$ output	16.6		41.6	MHz
		$\div 16$ output	12.5		31.25	MHz
		$\div 24$ output	8.33		20.83	MHz
t_{PW}	CLKx pulse width		2.0			ns
t_{tR}, t_{tF}	Input CLKx Rise/Fall time	0.8V to 2.0V			1	ns
$t_{(\phi)}$	Propagation Delay (static phase offset) ^a	CLK to FB_IN $f_{REF} = 50\text{MHz}$ & $FB = \div 8$	-250		+100	ps
$t_{SK(O)}$	Output to output skew	Bank A (QAx to QAy)			100	ps
		Bank B (QBx to QBy)			125	ps
		Bank C (QCx to QCy)			100	ps
		all outputs (QXy to QWz)			175	ps
DC	Output duty cycle		47	50	53	%
O_{tR}, O_{tF}	Output Rise/Fall time	0.55 to 2.4V	0.1		1.0	ns
t_{PLZ}, t_{PHZ}	Output Disable Time				10	ns
t_{PZL}, t_{PZH}	Output Enable Time				10	ns
$t_{JIT(CC)}$	Cycle-to-Cycle Jitter Time	All outputs @ same frequency			90	ps
$t_{JIT(PER)}$	Period Jitter	All outputs @ same frequency			90	ps
$t_{JIT(\phi)}$	I/O Phase Jitter (rms) VCO= 400MHz	$\div 8$ feedback			15	ps
		$\div 12$ feedback			49	ps
		$\div 16$ feedback			18	ps
		$\div 24$ feedback			22	ps
		$\div 32$ feedback			26	ps
		$\div 48$ feedback			34	ps

NOTE:

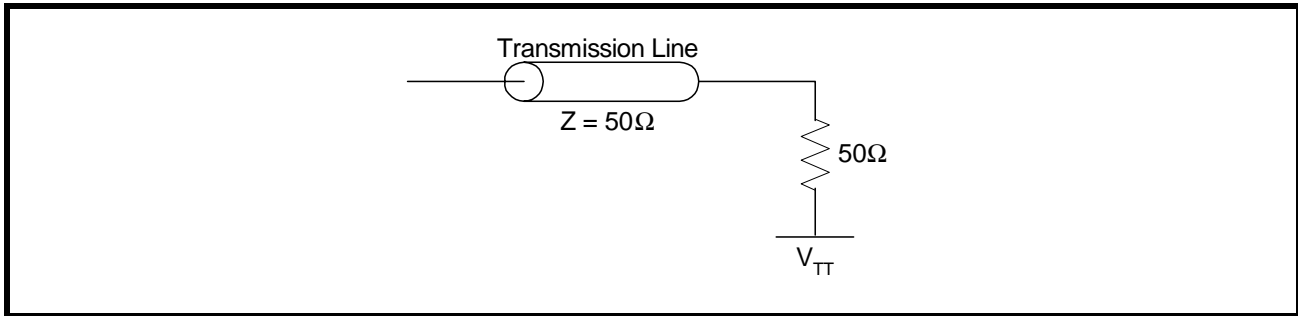
- a. $t_{(\phi)} = +50\text{ps} \pm (1 \div (120 \times f_{REF}))$ for any reference frequency.

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TABLE 5: AC CHARACTERISTICS ($V_{DD} = 3.3V \pm 5\%$)

SYMBOL	CHARACTERISTICS	CONDITION	MIN	TYP	MAX	UNIT
BW	PLL closed loop bandwidth	÷8 feedback		0.50-1.80		MHz
		÷12 feedback		0.30-1.00		MHz
		÷16 feedback		0.25-0.70		MHz
		÷24 feedback		0.17-0.40		MHz
		÷32 feedback		0.12-0.30		MHz
		÷48 feedback		0.07-0.20		MHz
t_{LOCK}	Maximum PLL Lock Time				10	ms

FIGURE 3. TEST LOAD



2.0 CONFIGURATION TABLES

TABLE 6: FUNCTION CONTROLS

CONTROL PIN	DEFAULT	LOGIC 0	LOGIC 1
MR/OE	1	Resets the output divide circuitry and serial interface, tri-states all outputs	Enables all outputs - normal operation
PLL_EN	1	PLL bypass mode enabled. This is a test mode in which the reference clock is provided to the output dividers in place of the VCO output.	PLL enabled - normal operation
STOP_CLK	1	QA[4:0], QB[4:0] and QC[3:0] outputs disabled in Low state.	Outputs enabled, normal operation
CLK_SEL	0	CLK0 selected as PLL reference	CLK1 selected
VCO_SEL	0	VCO ÷ 2	VCO ÷ 4

TABLE 7: BANK OUTPUT DIVIDER CONTROLS

INPUT		OUTPUT	INPUT		OUTPUT	INPUT		OUTPUT
VCO_SEL	FSEL_A	QA[4:0]	VCO_SEL	FSEL_B	QB[4:0]	VCO_SEL	FSEL_C	QC[3:0]
0	0	÷4	0	0	÷4	0	0	÷8
0	1	÷8	0	1	÷8	0	1	÷12
1	0	÷8	1	0	÷8	1	0	÷16
1	1	÷16	1	1	÷16	1	1	÷24

TABLE 8: FEEDBACK DIVIDER CONTROL

VCO_SEL	FSEL_FB1	FSEL_FB0	QFB
0	0	0	÷8
0	0	1	÷16
0	1	0	÷12
0	1	1	÷24
1	0	0	÷16
1	0	1	÷32
1	1	0	÷24
1	1	1	÷48

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FIGURE 4. OUTPUT-TO-OUTPUT SKEW $t_{SK(O)}$

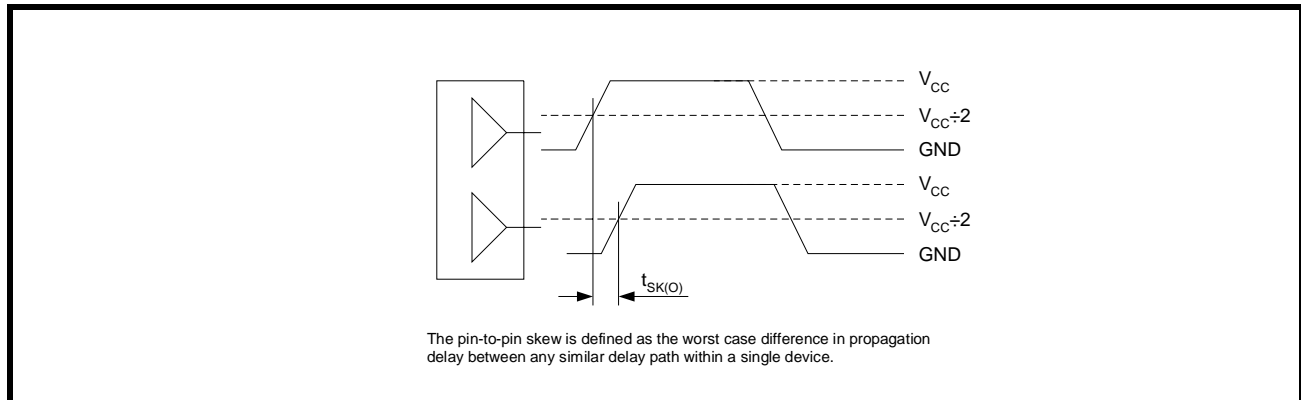


FIGURE 5. PROPOGATION DELAY ($t_{(\emptyset)}$, STATIC PHASE OFFSET) TEST REFERENCE

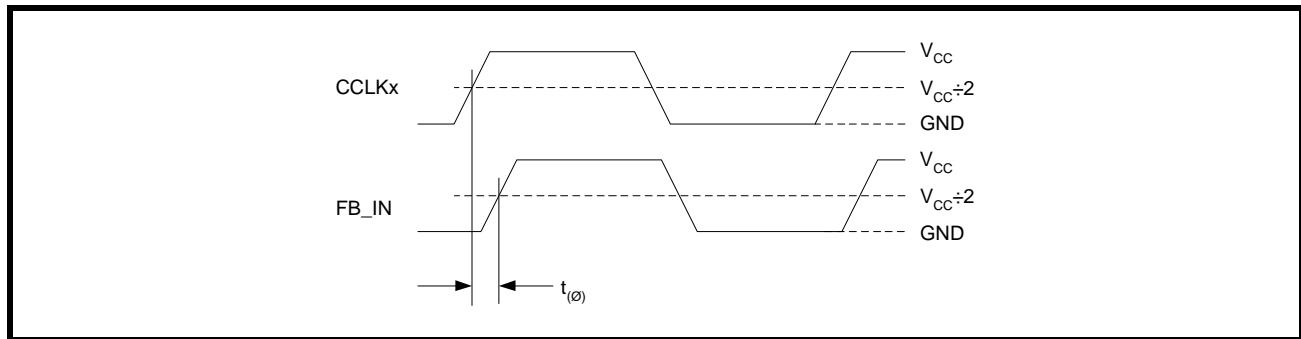


FIGURE 6. OUTPUT DUTY CYCLE (DC)

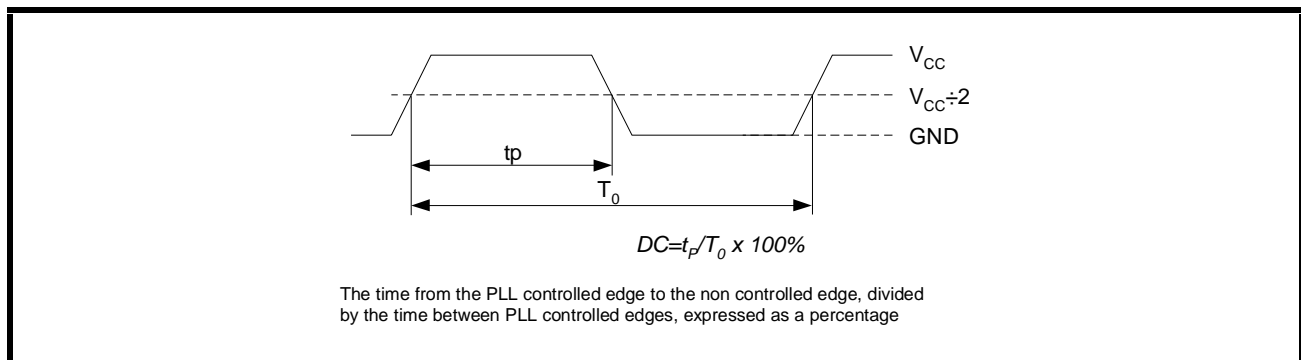


FIGURE 7. I/O JITTER

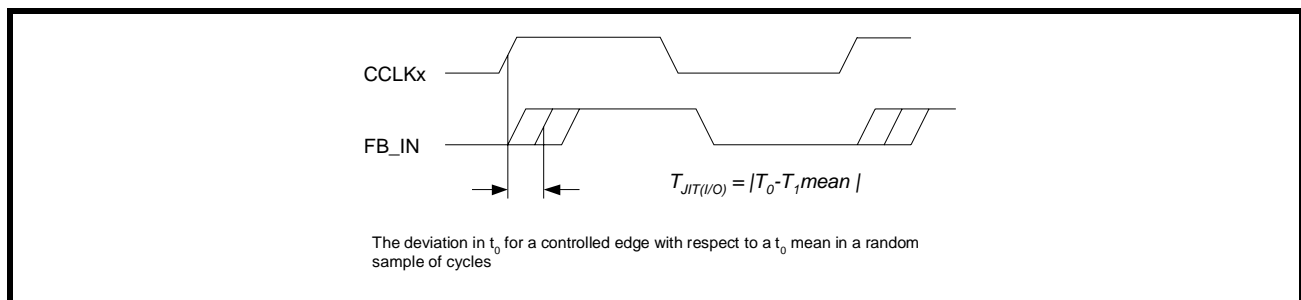


FIGURE 8. CYCLE-TO-CYCLE JITTER

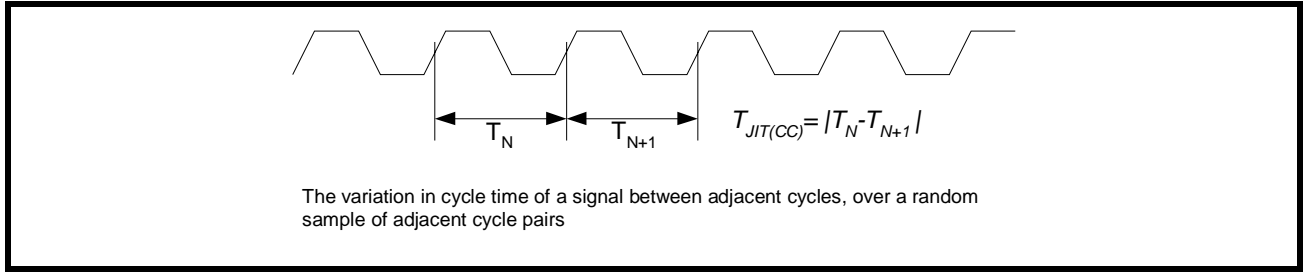


FIGURE 9. PERIOD JITTER

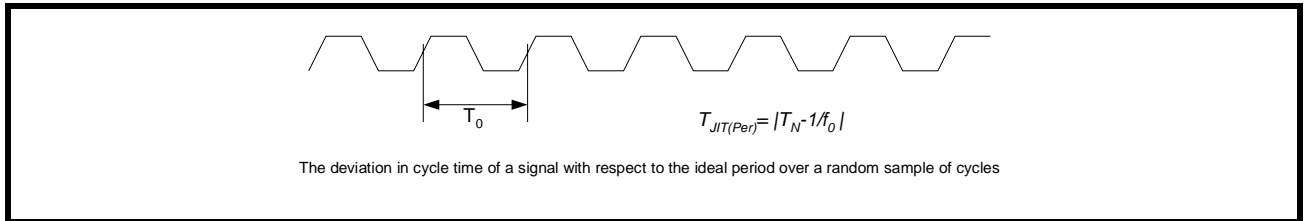
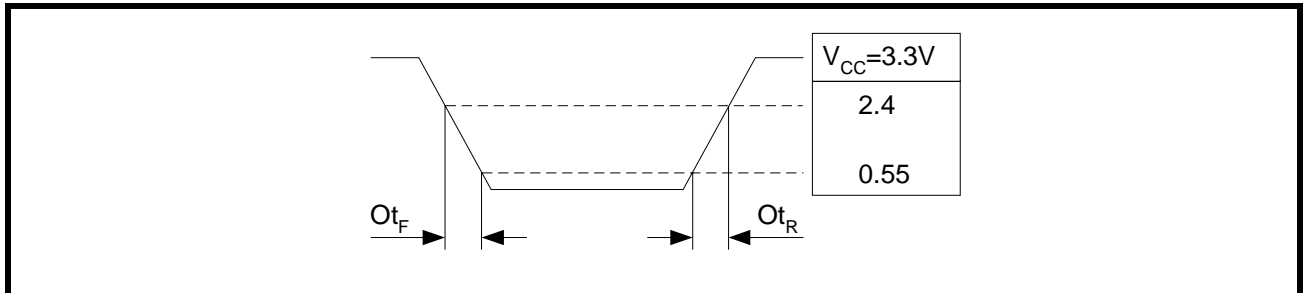


FIGURE 10. OUTPUT TRANSITION TIME TEST REFERENCE



PACKAGE DIMENSIONS

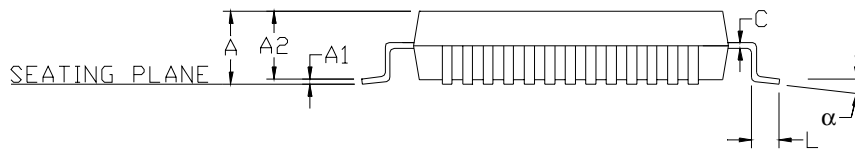
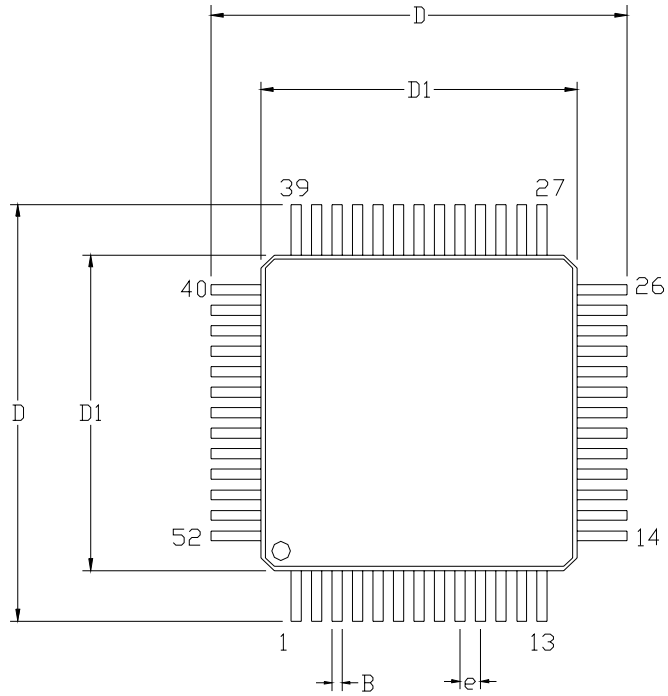


52 LEAD LOW-PROFILE QUAD FLAT PACK
(10 mm x 10 mm X 1.4 mm LQFP, 1.0 mm Form)

Rev. 1.00

Note: The control dimension is in millimeters.

SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.055	0.063	1.40	1.60
A1	0.002	0.006	0.05	0.15
A2	0.053	0.057	1.35	1.45
B	0.010	0.014	0.25	0.35
C	0.004	0.009	0.11	0.23
D	0.465	0.480	11.80	12.20
D1	0.390	0.398	9.90	10.10
e	0.0256 BSC		0.65 BSC	
L	0.029	0.041	0.73	1.03
α	0°	7°	0°	7°



REVISION HISTORY

REVISION #	DATE	DESCRIPTION
P1.0.0	April 7, 2006	Initial release
P1.0.1	April 10, 2006	General Description edit last line to: ...input frequency range of 4.16MHz to 62.5MHz.

NOTICE

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Datasheet April 2006.

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